# **Connectivity Industry Consortium (CIC)**

The Universal Standard for Point of Care Connectivity

# **CIC Technical Meeting Summary**

July 27<sup>th</sup>, 2000 San Francisco, California



This memo summarizes the essential details of the Point of Care Connectivity Industry Consortium (CIC) Technical Meeting, held July 17 at the Palace Hotel in San Francisco. Bayer Diagnostics hosted this third technical working meeting for the CIC. Fifty-seven attendees from 28 CIC member organizations reviewed the CIC's progress toward standards to enable interoperable reporting of patient test results by point-of-care devices. The meeting participants also refined the Consortium's timeline, and drafted plans to extend the standards to support ordering and QA/QC workflows.



### 1. EXECUTIVE SUMMARY

The Connectivity Industry Consortium held its third major technical meeting on July 27, 2000, in San Francisco. This meeting was sponsored by Bayer Diagnostics, and attended by 57 individuals from 27 CIC member organizations.

The objectives of this meeting were to review the Consortium's technical progress to date and to launch the final round of the development work with face-to-face meetings. The meeting participants reviewed the first Device and EDI message specifications, device connectivity protocols, system compatibility specification, and remaining technical timeline. They also developed detailed work plans for the next 8 weeks.

The Consortium's original goal, to complete work and sunset within 12-15 months, is attainable if the Consortium's workgroups maintain the rate of progress achieved to date. Over the remaining 5-7 months of the Consortium's lifetime, the technical teams will complete specifications to enable core point-of-care device data management interoperability. To ameliorate the effects of the end-of-year holiday season, the CIC aims to complete the majority of the technical specifications by the beginning of November 1999.

In general, attendees of the July 27<sup>th</sup> meeting responded positively to the technical development reviewed. In summary, the participants found the progress to date to be ontarget and on-schedule. When asked to rate how well the Consortium's progress had met their expectations, respondents replied with an average score of 7.89 (on a scale of 1 to 10). No participant indicated that the Consortium's progress had failed to meet his/her expectations.

Issue cards distributed during the meeting captured attendees' comments and feedback. Comments on these cards identified several issues that require further definition:

#### 1. Compatibility

'Vendors must be able to make their systems easily interoperate with other vendors' offerings'

'Non-technical users (customers) must understand how to specify compatible systems from multiple vendors'

#### 2. LIS Participation

'We need stronger LIS participation to ensure implementation success.'

#### 3. Implementation Cost

'We must make sure that there are low-cost means to implement the standards'

A comprehensive plan to address these issues, as well as the other input gathered from the breakout sessions, will be posted on the CIC website (<a href="http://www.poccic.org">http://www.poccic.org</a>) and incorporated into the technical team's work plans.

The Consortium's next technical meeting will be held on September 22 in St. Louis, in conjunction with the HL7 Fall Working Group meeting.



## 2. PARTICIPANTS

Attendance at the San Francisco CIC Technical Meeting totaled 57 individuals representing 28 organizations from 15 states and 4 countries. The participants and their organizations are summarized below; detailed listings may be found on the CIC website <a href="http://www.poccic.org">http://www.poccic.org</a>.

	PARTICIPANTS	ORGANIZATIONS
IS/IT companies	10	5
POC/IVD companies	34	14
POC customers/users	9	6
Others	4	3
Total	57	28

### 3. TECHNICAL PROGRESS

### Summary

The Consortium achieved all of the technical milestones planned for the San Francisco meeting. These milestones were to:

- 1. Draft the Simple Test Result message specifications
- 2. Demonstrate prototypes of the EDI and Device interfaces

In addition to these goals, the Consortium's technical teams accomplished an important supplementary objective: to draft initial definitions for a CIC system compatibility specification.

## Organization

For the three months since the end of the Phase 0 period, the Consortium's technical teams have been organized as shown the figure below. This organizational structure will persist through the remainder of the Development Phase, projected to last until the beginning of November.



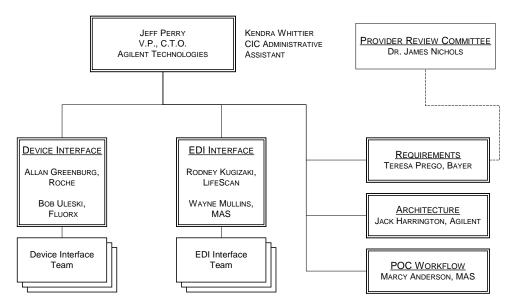


Figure 1: Development Phase Technical Organization

# **Prototypes**

Two member organizations publicly demonstrated prototype implementations of the draft CIC standards in the Consortium's booth on the AACC exhibit floor. Agilent Technologies demonstrated the CIC Device interface, showing point-of-care applications on several palmtops wirelessly communicating test results via an infrared connection to a simple data manager. Medical Automation Systems exhibited their point-of-care data manager sending CIC-standard test result messages to a simulated LIS system, using HL7's enhanced acknowledgement protocol.



Figure 2: CIC AACC booth – prototypes on display on tables<sup>1</sup>

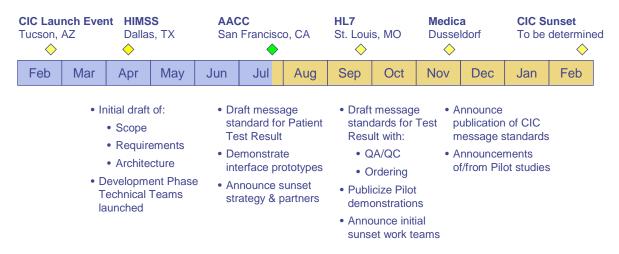
<sup>&</sup>lt;sup>1</sup> Thanks to Joan Portwood, BD, for this photo, captured on a Handspring palmtop.



# 4. REMAINING TIMELINE, MILESTONES

The July 27 San Francisco meeting fell approximately at the mid-point of the Consortium's 12-15 month lifespan. As of this meeting, the Consortium has met all planned milestones and objectives.

Over the remaining 5-7 months of the Consortium's lifetime, the technical teams will complete specifications to enable core point-of-care device data management interoperability. To ameliorate the effects of the end-of-year holiday season, the CIC aims to complete the majority of the technical specifications by the beginning of November 1999.



## **Remaining Meetings**

The CIC has only two remaining meetings scheduled. As with all previous meetings, these events will coincide with major industry conferences.

### September 15, 2000: HL7 Fall Working Group (St. Louis, MO)

- Review draft message specifications for QA/QC and ordering
- Announce initial sunset work teams

# November 21, 2000: Medica (Dusseldorf, Germany)

- Announce publication schedule for CIC standards
- Announce results of/from Pilot studies



### 5. EVALUATION AND FEEDBACK

#### **Evaluation**

Attendees were asked to evaluate the Consortium's progress. Specifically, participants were asked to answer the following question:

How well is the Consortium doing, relative to your expectations?

Participants responded with a number between one and ten from the following scale:



The 43 evaluation scores were distributed as follows:

High: **11** 

Low: 5

Average: 7.89

#### **Feedback and Suggestions**

The average score of 7.89 is impressive, considering the Consortium's aggressive timeline and unprecedented vision and objectives. As illustrated by this score, participants generally were very pleased with the Consortium's progress.

During the meeting, 'issue cards' were distributed to each attendee to capture comments and observations on the following topics: Device interface, EDI interface, General issues. During the afternoon breakout sessions, the technical teams reviewed the comment cards, and drafted plans and timelines to address the major issues raised. Transcripts of these comments will be made available on the Members Only section of the CIC website.

# 6. July 27<sup>th</sup> Meeting Attendees

### Attendance Summary

Total Attendance: 57 individuals,

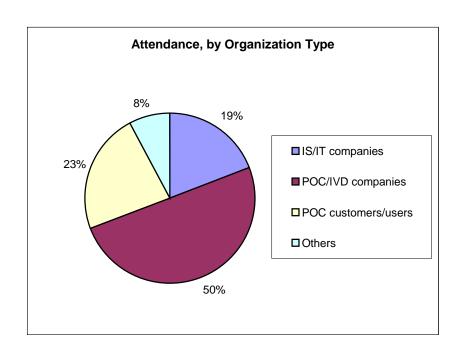
28 organizations

Geographic Distribution: 15 states,

4 countries



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POC customers/users	9	6
Others	4	3
Total	57	28



# Attendees, By Organization

57 individuals from 28 CIC member organizations attended the San Francisco CIC Technical Meeting.



Авво	TT DIAGNOSTICS			
	Gary	Ken	Bedford	MA
AGILE	ENT TECHNOLOGIES			
	Anders	Bob	Andover	MA
	Kellett	Stephen	Andover	MA
	Perry	Jeffrey	Palo Alto	CA
	Whittier	Kendra	Palo Alto	CA
	Boecker	Dirk	Palo Alto	CA
	Frey	David	Palo Alto	CA
A \ /I	SCIENTIFIC			
AVL			D "	
	Merkle	Horst	Roswell	GA
AVOCET				
	Zweig	Steven	San Jose	CA
	J			
BAYE	R DIAGNOSTICS			
	Cross	Mark	Franklin Lakes	NJ
	Prego	Teresa	Medfield	MA
BD				
	Portwood	Joan	Research Triangle Pa	ark NC
	Powell	Kenneth	Franklin Lakes	NJ
_				
CERN				
	Compton	David	Kansas City	MO
Connectivity Industry Consortium				
	Uleski	Bob	Carmel	IN
GE-MARQUETTE MEDICAL SYSTEMS				
	Nowicki	Dan	Milwaukee	WI



GEISII	nger Medical Cen	ΓER		
	Jones	Jay	Danville	PA
	Lebo	Rick	Danville	PA
ΗξΔΙ	TH LEVEL SEVEN			
I IL/ (L	Hawker	Charles	St. Louis	MO
	Knafel	Andrzej	ot. Louis	SWITZERLAND
	Miaici	Alluizej		OWNZERLAND
Немс	CUE			
	Burgess	Bruce	Mission Viejo	CA
	Girvan	Roy	Mission Viejo	CA
	Wright	Roy	Mission Viejo	CA
INSTR	RUMENTATION LABOR	RATORIES		
	Azer	Anwar	Lexington	MA
	Fannon	Bill	Lexington	MA
	Lachs	Steve	Lexington	MA
	Landry	Dana	Lexington	MA
INTER	COMPONENT WARE			
	Roesner	Helmut		GERMANY
ı-STA	AT CORPORATION			
	Maund	Mark	East Windsor	NJ
	Raimo	Tom	East Windsor	NJ
ITC CORP				
	Gavin	Michael	Edison	NJ
Johns Hopkins				
	Nichols	Dr. Jim	Baltimore	MD
Kaiser-Permanente				



	Greene Lowensohn Vernay	Sandra Dr. Brent Carol	Pasadena Pasadena Pasadena	CA CA	
	·				
LIFESC					
	Dunka	Lou	Milpitas	CA	
	Kugizaki	Rodney	Milpitas	CA	
	Narsipur	Deepak	Milpitas	CA	
	Trefil	Imre	Milpitas	CA	
Мауо	CLINIC				
	Santrach	Dr. Paula	Rochester	MN	
MEDIC	CAL AUTOMATION S	YSTEMS			
	Anderson	Marcy	Harrisburg	PA	
	Fetters	Chris	Harrisburg	PA	
	Keller	Billie	Harrisburg	PA	
	Mullins	Wayne	Charlottesville	VA	
	Valorz	Steve	Charlottesville	VA	
THE MT. SINAI HOSPITAL					
	Jacobs	Dr. Ellis	New York	NY	
Pharmacia & Upjohn					
	Bjorkman	Rune		GERMANY	
	Matsson	Per		GERMANY	
POINT-OF-CARE CONSULTANT					
	Schindler	Charles	Petaluma	CA	
RADIOMETER					
	Soerensen	Allan		DENMARK	
	Kjoller	Klaus		DENMARK	



ROCHE DIAGNOSTICS					
	Levy	Ken	Indianapolis	IN	
	Greenburg	Alan	Indianapolis	IN	
	Beck	Tim	Indianapolis	IN	
TELCOR, INC.					
	Cederdahl	Mark	Lincoln	NE	
	Terrano	Jim	Lincoln	NE	
University of Washington					
	Rainey	Dr. Petrie	Seattle	WA	